

RoH

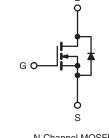
COMPLIANT



## **Power MOSFET**

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	400			
R <sub>DS(on)</sub> (Ω)	$V_{GS} = 10 V$	0.20		
Q <sub>g</sub> (Max.) (nC)	210			
Q <sub>gs</sub> (nC)	30			
Q <sub>gd</sub> (nC)	110			
Configuration	Single			





#### N-Channel MOSFET

### FEATURES

- Dynamic dV/dt Rated
- Repetitive Avalanche Rated
- Isolated Central Mounting Hole
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC

### DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-247AC package is preferred for commercial-industrial applications where higher power levels preclude the use of TO-220AB devices. The TO-247AC is similar but superior to the earlier TO-218 package because of its isolated mounting hole. It also provides greater creepage distance between pins to meet the requirements of most safety specifications.

ORDERING INFORMATION	
Package	TO-247AC
Lead (Pb)-free	IRFP360PbF
Lead (FD)-liee	SiHFP360-E3
SnPb	IRFP360
	SiHFP360

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V <sub>DS</sub>	400	V	
Gate-Source Voltage			V <sub>GS</sub>	± 20		
Continuous Drain Current	V <sub>GS</sub> at 10 V	$T_{\rm C} = 25 ^{\circ}{\rm C}$		23		
	VGS at 10 V	$T_{C} = 100 ^{\circ}C$	I <sub>D</sub>	14	A	
Pulsed Drain Current <sup>a</sup>	I <sub>DM</sub>	92				
Linear Derating Factor		2.2	W/°C			
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	1200	mJ	
Repetitive Avalanche Current <sup>a</sup>			I <sub>AR</sub>	23	А	
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	28	mJ	
Maximum Power Dissipation $T_{C} = 25 \text{ °C}$			PD	280	W	
Peak Diode Recovery dV/dt <sup>c</sup>	dV/dt	4.0	V/ns			
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	°C	
Soldering Recommendations (Peak Temperature)	oldering Recommendations (Peak Temperature) for 10 s			300 <sup>d</sup>		
Mounting Torque	6 22 or N	12 001014		10	lbf ∙ in	
Mounting Torque	6-32 or M3 screw			1.1	N · m	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b.  $V_{DD} = 50$  V, starting  $T_J = 25$  °C, L = 4.0 mH,  $R_q = 25 \Omega$ ,  $I_{AS} = 23$  A (see fig. 12).

c.  $I_{SD} \le 23$  A, dl/dt  $\le 170$  A/µs,  $V_{DD} \le V_{DS}$ ,  $T_J \le 150$  °C.

d. 1.6 mm from case.

\* Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RATI	NGS							
PARAMETER	SYMBOL	TYP.		MAX.			UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	- 40						
Case-to-Sink, Flat, Greased Surface	R <sub>thCS</sub>	0.24		-			°C/W	
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-		0.45				
<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 $^{\circ}$ C, u	unless otherw	vise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static						•	•	
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0$	V, I <sub>D</sub> = 250	μA	400	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference t	o 25 °C, I <sub>D</sub> =	= 1 mA	-	0.56	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_0$	<sub>GS</sub> , I <sub>D</sub> = 250	μA	2.0	-	4.0	V
Gate-Source Leakage	I <sub>GSS</sub>	V <sub>G</sub> s	<sub>5</sub> = ± 20 V		-	-	± 100	nA
		$V_{DS} = 40$	00 V, V <sub>GS</sub> = 0	D V	-	-	25	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 320 V, V	<sub>GS</sub> = 0 V, T <sub>J</sub>	= 125 °C	-	-	250	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> =	14 A <sup>b</sup>	-	-	0.20	Ω
Forward Transconductance	9 <sub>fs</sub>	$V_{DS} = 5$	0 V, I <sub>D</sub> = 14	A <sup>b</sup>	14	-	-	S
Dynamic						<u> </u>	<u> </u>	1
Input Capacitance	C <sub>iss</sub>	N 0)/		-	4500	-		
Output Capacitance	C <sub>oss</sub>	$V_{GS} = 0 V,$		1100	-	pF		
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1.0 M	MHz, see fig	. 5	-	490	-	1
Total Gate Charge	Qg				-	-	210	nC
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	$I_D = 23 \text{ A}, V$	/ <sub>DS</sub> = 320 V, 6 and 13 <sup>b</sup>	-	-	30	
Gate-Drain Charge	Q <sub>gd</sub>		see lig.		-	-	110	
Turn-On Delay Time	t <sub>d(on)</sub>		1		-	18	-	
Rise Time	t <sub>r</sub>	- 	0 V, I <sub>D</sub> = 23	٨	-	79	-	
Turn-Off Delay Time	t <sub>d(off)</sub>	$v_{DD} = 20$ $R_g = 4.3 \Omega, R_D$			-	100	-	ns
Fall Time	t <sub>f</sub>				-	67	-	
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from			-	5.0	-	
Internal Source Inductance	Ls	package and cer die contact	nter of		-	13	-	nH
Drain-Source Body Diode Characteristic	s					•	•	
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbo showing the	l		-	-	23	- A
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>	integral reverse p - n junction dic			-	-	92	
Body Diode Voltage	$V_{SD}$	T <sub>J</sub> = 25 °C, I <sub>5</sub>	$_{\rm S}$ = 23 A, $V_{\rm G}$	<sub>S</sub> = 0 V <sup>b</sup>	-	-	1.8	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	T <sub>J</sub> = 25 °C, I <sub>F</sub> = 2	03 0 di/d+ -	100 A/ucb	-	420	630	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	$I_{\rm J} = 23$ C, $I_{\rm F} = 2$	23 A, ui/ut =	· · · · · · · · · · · · · · · · · · ·	-	5.6	8.4	μC
		Intrinsic turn-on time is negligible (turn-						

### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width  $\leq$  300 µs; duty cycle  $\leq$  2 %.

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I<sub>D</sub>, Drain Current (Amps)

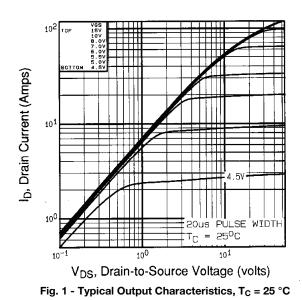
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10<sup>0</sup>

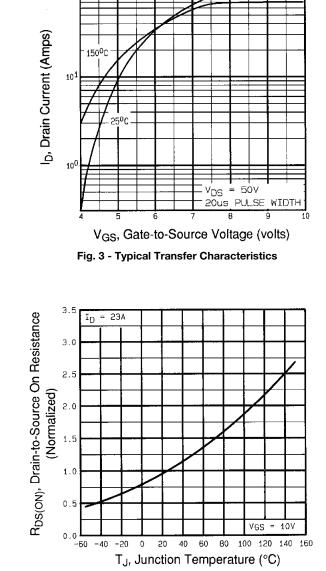
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# IRFP360, SiHFP360

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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



102

V<sub>DS</sub>, Drain-to-Source Voltage (volts)

10<sup>0</sup>

5٧

WIDTH

20us PULSE

 $T_{\rm C} = 150^{\rm O}{\rm C}$ 

101

Fig. 2 - Typical Output Characteristics,  $T_C$  = 150  $^\circ C$ 



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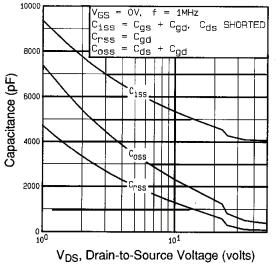
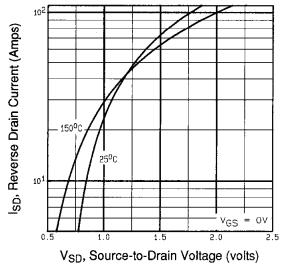


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage





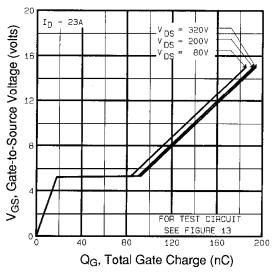
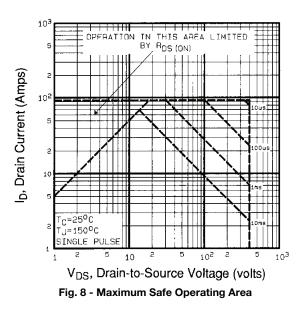


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



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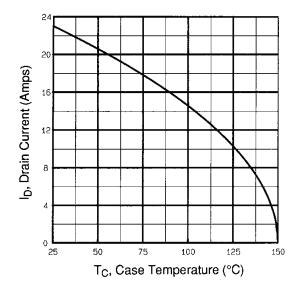


Fig. 9 - Maximum Drain Current vs. Case Temperature

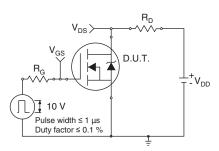


Fig. 10a - Switching Time Test Circuit

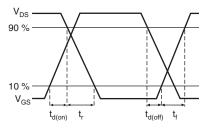
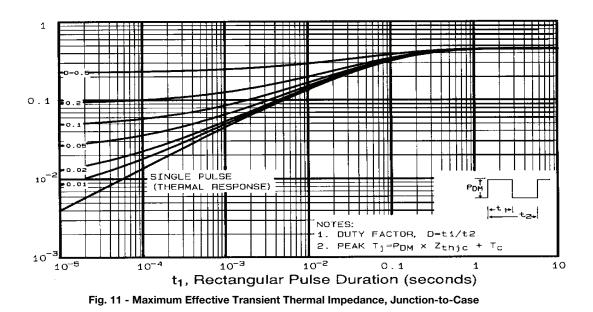


Fig. 10b - Switching Time Waveforms



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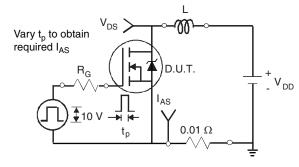


Fig. 12a - Unclamped Inductive Test Circuit

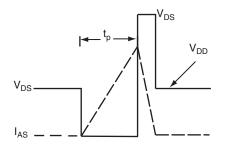


Fig. 12b - Unclamped Inductive Waveforms

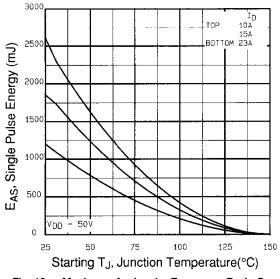
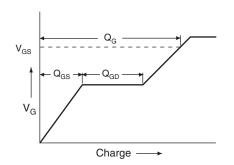


Fig. 12c - Maximum Avalanche Energy vs. Drain Current





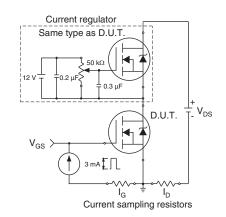
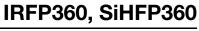
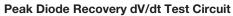


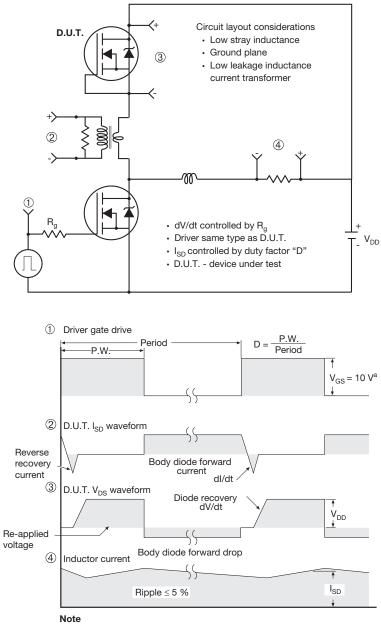
Fig. 13b - Gate Charge Test Circuit

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a.  $V_{GS} = 5 V$  for logic level devices

Fig. 14 - For N-Channel

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## TO-247AC (High Voltage)

### VERSION 1: FACILITY CODE = 9





Section C--C, D--D, E--E

	MILLIN	MILLIMETERS			
DIM.	MIN.	MAX.	NOTES		
А	4.83	5.21			
A1	2.29	2.55			
A2	1.50	2.49			
b	1.12	1.33			
b1	1.12	1.28			
b2	1.91	2.39	6		
b3	1.91	2.34			
b4	2.87	3.22	6, 8		
b5	2.87	3.18			
С	0.55	0.69	6		
c1	0.55	0.65			
D	20.40	20.70	4		

	MILLIN	IETERS			
DIM.	MIN.	MAX.	NOTES		
D1	16.25	16.85	5		
D2	0.56	0.76			
E	15.50	15.87	4		
E1	13.46	14.16	5		
E2	4.52	5.49	3		
е	5.44	5.44 BSC			
L	14.90	15.40			
L1	3.96	4.16	6		
ØP	3.56	3.65	7		
Ø P1	7.19	7.19 ref.			
Q	5.31	5.69			
S	5.54	5.74			

#### Notes

- <sup>(1)</sup> Package reference: JEDEC<sup>®</sup> TO247, variation AC
- (2) All dimensions are in mm
- <sup>(3)</sup> Slot required, notch may be rounded
- <sup>(4)</sup> Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm per side. These dimensions are measured at the outermost extremes of the plastic body
- <sup>(5)</sup> Thermal pad contour optional with dimensions D1 and E1
- (6) Lead finish uncontrolled in L1
- (7) Ø P to have a maximum draft angle of 1.5° to the top of the part with a maximum hole diameter of 3.91 mm
- (8) Dimension b2 and b4 does not include dambar protrusion. Allowable dambar protrusion shall be 0.1 mm total in excess of b2 and b4 dimension at maximum material condition



### VERSION 2: FACILITY CODE = Y



	MILLIN	MILLIMETERS			MILLI		
DIM.	MIN.	MAX.	NOTES	DIM.	MIN.	MAX.	NOTE
А	4.58	5.31		D2	0.51	1.30	
A1	2.21	2.59		E	15.29	15.87	
A2	1.17	2.49		E1	13.72	-	
b	0.99	1.40		е	5.46	BSC	
b1	0.99	1.35		Øk	0.	254	
b2	1.53	2.39		L	14.20	16.25	
b3	1.65	2.37		L1	3.71	4.29	
b4	2.42	3.43		ØР	3.51	3.66	
b5	2.59	3.38		Ø P1	-	7.39	
С	0.38	0.86		Q	5.31	5.69	
c1	0.38	0.76		R	4.52	5.49	
D	19.71	20.82		S	5.51	BSC	
D1	13.08	-					

#### Notes

- <sup>(1)</sup> Dimensioning and tolerancing per ASME Y14.5M-1994
- (2) Contour of slot optional
- (3) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- <sup>(4)</sup> Thermal pad contour optional with dimensions D1 and E1
- <sup>(5)</sup> Lead finish uncontrolled in L1
- (6) Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- <sup>(7)</sup> Outline conforms to JEDEC outline TO-247 with exception of dimension c



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